05-29-2002



Atty. Docket No.: 0465-0889P

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OVER SHEET 102105639 To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof. 1. Name of conveying party(ies): 2. Name and address of receiving party(ies) [FAMILY NAME (ALL CAPS), Given Name] Name: HYNIX SEMICONDUCTOR INC. KIM, Si Bum Internal Address: Additional name(s) of conveying party(ies) attached? Street Address: San 136-1, Ami-ri, Bubal-eub ☐ YES ⊠ NO ZIP: 3. Nature of conveyance: City: Ichon-shi State: Kyoungki-do Country: KOREA Postal Code: ☐ Merger Additional name(s) & address(es) attached?

YES NO Security Agreement Change of Name Other: Execution Date: April 5, 2002 4. Application number(s) or patent number(s): If this document is being filed together with a new application, of the application is: April 5, 2002 A. Patent Application No(s). B. Patent No.(s). **NEW** Additional numbers attached?

YES

NO 6. Total No. of applications/patents involved: One (1) 5. Name and address of party to whom correspondence concerning document should be mailed: 7. Total fee (37 C.F.R. § 3.41): \$40.00 Name: BIRCH, STEWART, KOLASCH & BIRCH, LLP Street Address: P.O. BOX 747 Authorized to be charged to deposit account, if no fee attached. ZIP: 22040-0747 City: FALLS CHURCH State: VA 8. Deposit account number: 02-2448 Country: USA (Attach triplicate copy of this page if paying by deposit account) DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. May 23, 2002 Joseph A. Kolasch, #22,463 Name of Person Signing/Reg. Total number of pages including cover sheet, attachments, and document: Three (3) JAK/jaf

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(Rev. 02/11/02)

PATENT REEL: 012921 FRAME: 0759

BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

	Application No. NEW		Filed May 23 , 2002
nsert Name(s) f Inventor(s)			
	WHEREAS,	Si Bum KIM	
	-	1777	
	(harainaftar designated as the under	rsigned) has (have) invented certain new and	d ugoful immovements in
	(heremaner designated as the under	rsigned) has (have) invented certain new and	d userui improvements in
nsert Title f Invention	SEMICONDUCTOR DEVICE HA	AVING A METAL INSULATOR META	L CAPACITOR
	for which an application for Lette undersigned (except in the case of a	ers Patent of the United States of America provisional application).	ca has been executed by the
nsert Date f Signing of pplication	on <u>April 5, 2002</u> ; and		
nsert Name f Assignee	WHEREAS, Hynix S	Semiconductor Inc.	
nsert Address f Assignee	of San 136-1, Ami-ri, Bu	ubal-eub, Ichon-shi, Kyoungk	i-do, Korea
снеск вох	its heirs, successors, legal represen acquiring the entire right, title and may be granted therefor in the Unit in any foreign countries.	statives and assigns (hereinafter designated a I interest in and to said invention and in an ted States of America and	as the Assignee) is desirous of d to any Letters Patent(s) that
F APPROPRIATE	the receipt of which is hereby ack has (have) sold, assigned and tra Assignee the full and exclusive ri dependencies and possessions and which may be granted therefor in and if the box above is designated	ation of the sum of Ten Dollars (\$10.00) to knowledged, and other good and valuable consferred, and by these presents does sell, ight to the said invention in the United State of the entire right, title and interest in and the United States of America, its territories, I, in any and all foreign countries;	assign and transfer unto said ites of America, its territories, o any and all Letters Patent(s) dependencies and possessions,
	and to any and all divisions, reiss	ues, continuations, conversions and extensi	ons thereof for the full term or

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PATENT REEL: 012921 FRAME: 0760

0465-0889P

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date Apr: 1 5, 2002	Name of Inventor Si Bum KIM
Date,	Name of Inventor (signature)
Date,	Name of Inventor(signature)
Date,	Name of Inventor(signature)
Date,	Name of Inventor(signature)
Date	Name of Inventor(signature)

April 2000

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RECORDED: 05/23/2002